

Prevents Thermal Fatigue Cracks & Whiskers

Features

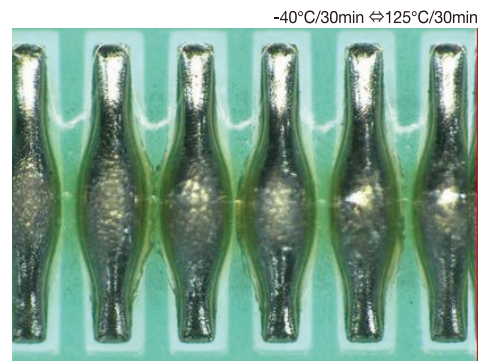
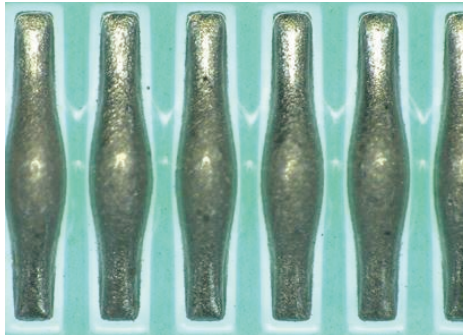
- No residual crack even in thermal fatigue resistance test
- Uncracked flux prevents migration causing condensation
- Prevents whiskers causing migration



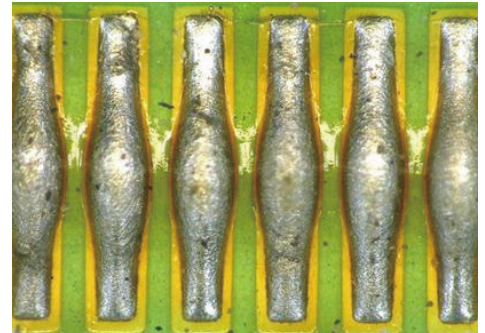
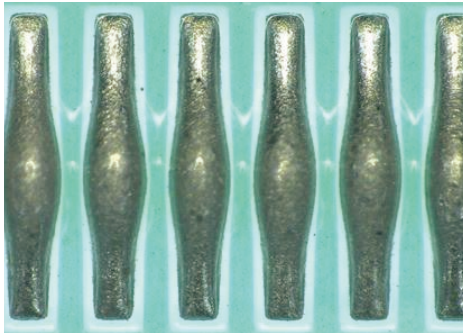
Revolutionary Products

- Solder paste C3T improved preventing residual crack

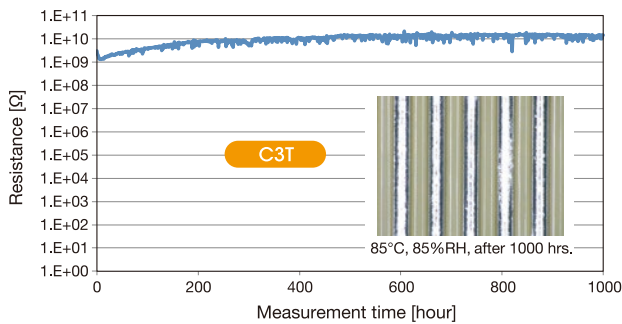
Conventional product



C3T



- No migration by high insulation resistance even in 85°C/85%RH test



- No migration causing condensation

